گروه فنی مهندسی جوش و برش مقدم



اعتماد از شما کیفیت و تخصص از ما

 \bigcirc

09153223758 051-37581400 https://www.moghadamwelding http://instagram.com/moghadam https://t.me/moghadamwelding https://whatsapp.com/channel https://rubika.ir/moghadamwelding

مشهد خیام شمالی 63 خیابان پردیس 3

برای کسب اطلاعات بیشتر بر روی لینک ها کلیک کنید

- 7 سال سابقه آموزش تعمیرات تخصصی دستگاه
 - های جوش اینورتری تک فاز و 3 فاز
- 7 سال سابقه فروش قطعات الكترونيكي دستگاه جوش تك فاز و 3 فاز
 - آموزش تخصصی تحلیل دستگاه های جوش
 اینورتری مختص ابراز فروشان
 - آموزش تخصصی ابراز آلات شارژی

Description

Using novel field stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder and PFC applications where low conduction and switching losses are essential.

Features

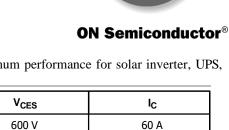
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 2.3 V (Typ.) @ I_C = 60 A$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

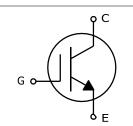
Applications

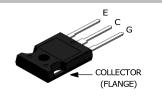
• Solar Inverter, UPS, Welder, PFC

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February, 2020 - Rev. 2

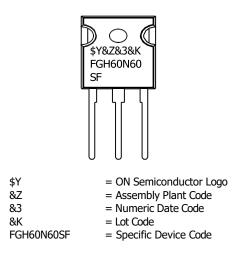






TO-247-3LD CASE 340CK

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

ON

ABSOLUTE MAXIMUM RATINGS

Symbol	Description		Ratings	Unit
V _{CES}	Collector to Emitter Voltage		600	V
V _{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate-to-Emitter Voltage	Gate-to-Emitter Voltage		V
IC	Collector Current	T _C = 25°C	120	А
	Ī	T _C = 100°C	60	А
ICM (Note 1)	Pulsed Collector Current	T _C = 25°C	180	А
PD	Maximum Power Dissipation	T _C = 25°C	378	W
	Ī	$T_C = 100^{\circ}C$	151	W
Tj	Operating Junction Temperature		–55 to +150	°C
T _{STG}	Storage Temperature Range		–55 to +150	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1	/8" from Case for 5 Seconds	300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive test: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Max.	Unit
R _{0JC} (IGBT)	Thermal Resistance, Junction to Case	-	0.33	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	-	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGH60N60SFTU	FGH60N60SF	TO-247	Tube	N/A	N/A	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS					
BV _{CES}	Collector to Emitter Breakdown Voltage	$V_{GE} = 0 V, I_C = 250 \mu A$	600	-	-	V
$\Delta BV_{CES} / \Delta T_J$	Temperature Coefficient of Breakdown Voltage	$V_{GE} = 0 V, I_C = 250 \mu A$	-	0.4	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
ON CHARACTE	RISTICS					
	G-E Threshold Voltage	$I_{C} = 250 \ \mu A, V_{CF} = V_{GF}$	4.0	5.0	6.5	V

V _{GE(th)}	G-E Threshold Voltage	$I_{C} = 250 \ \mu\text{A}, \ V_{CE} = V_{GE}$	4.0	5.0	6.5	V	
V _{CE(sat)}	Collector to Emitter Saturation Voltage	$I_{C} = 60 \text{ A}, V_{GE} = 15 \text{ V},$	-	2.3	2.9	V	
		$I_C = 60 \text{ A}, V_{GE} = 15 \text{ V}, T_C = 125^{\circ}\text{C}$	-	2.5	-	v	

DYNAMIC CHARACTERISTICS

C _{ies}	Input Capacitance	V _{CE} = 30 V, V _{GE} = 0 V, f = 1 MHz	-	2820	-	pF
Coes	Output Capacitance		-	350	-	pF
C _{res}	Reverse Transfer Capacitance		-	140	-	pF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
ITCHING C	HARACTERISTICS					
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A}, R_{G} = 5 \Omega, V_{GE} = 15 \text{ V},$	-	22	_	ns
Tr	Rise Time	Inductive Load, $T_C = 25^{\circ}C$	-	42	-	ns
T _{d(off)}	Turn-Off Delay Time		-	134	-	ns
T _f	Fall Time		-	31	62	ns
Eon	Turn-On Switching Loss		-	1.79	-	mJ
E _{off}	Turn-Off Switching Loss		-	0.67	-	mJ
E _{ts}	Total Switching Loss		-	2.46	-	mJ
T _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 60 \text{ A},$ $R_{G} = 5 \Omega, V_{GE} = 15 \text{ V},$	-	22	-	ns
Tr	Rise Time	Inductive Load, $T_C = 125^{\circ}C$	-	44	-	ns
T _{d(off)}	Turn-Off Delay Time		-	144	-	ns
T _f	Fall Time		-	43	-	ns
Eon	Turn-On Switching Loss		-	1.88	-	mJ
E _{off}	Turn-Off Switching Loss		-	1.0	-	mJ
E _{ts}	Total Switching Loss		-	2.88	Ι	mJ
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 60 A, V _{GF} = 15 V	-	198	-	nC
Q _{ge}	Gate to Emitter Charge	VGE = 15 V	-	22	-	nC
Q _{gc}	Gate to Collector Charge		-	106	-	nC

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

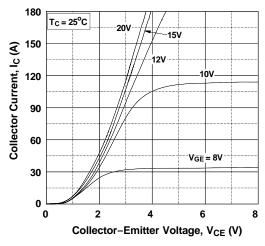
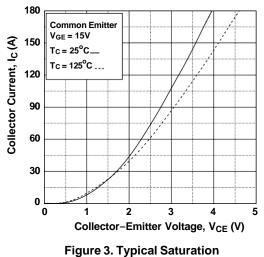
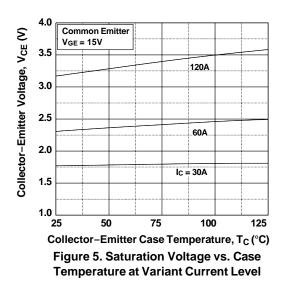


Figure 1. Typical Output Characteristics



Voltage Characteristics



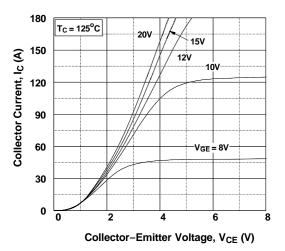


Figure 2. Typical Output Characteristics

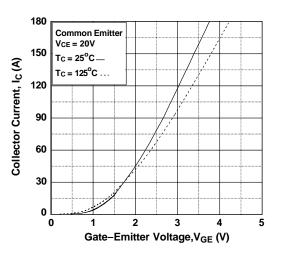


Figure 4. Transfer Characteristics

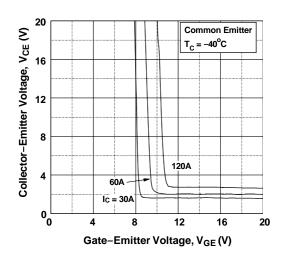


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

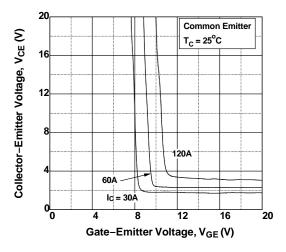


Figure 7. Saturation Voltage vs. VGE

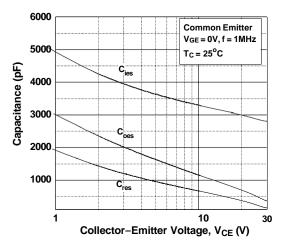
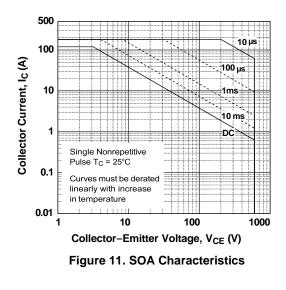


Figure 9. Capacitance Characteristics



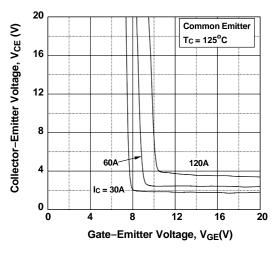


Figure 8. Saturation Voltage vs. VGE

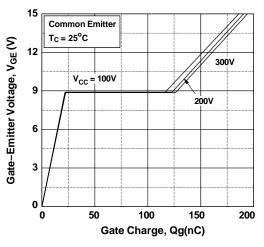
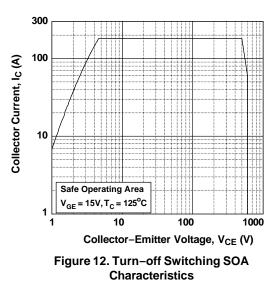
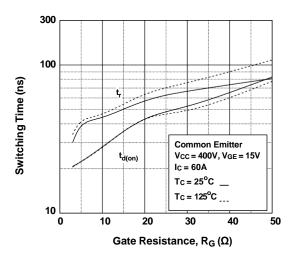


Figure 10. Gate Charge Characteristics



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





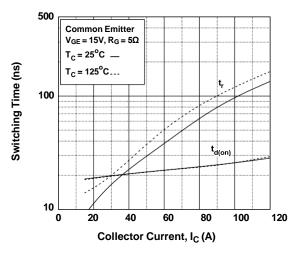


Figure 15. Turn-on Characteristics vs. Collector Current

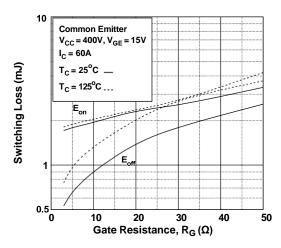
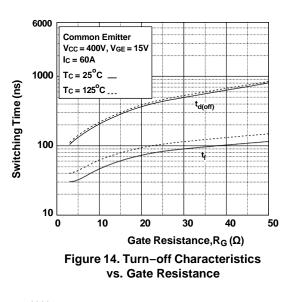


Figure 17. Switching Loss vs. Gate Resistance



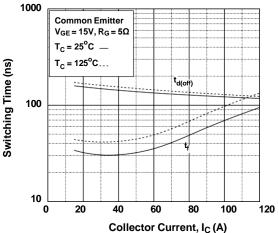


Figure 16. Turn-off Characteristics vs. Collector Current

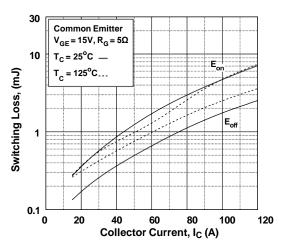


Figure 18. Switching Loss vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

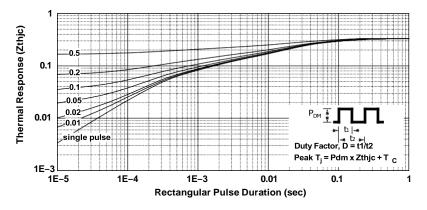
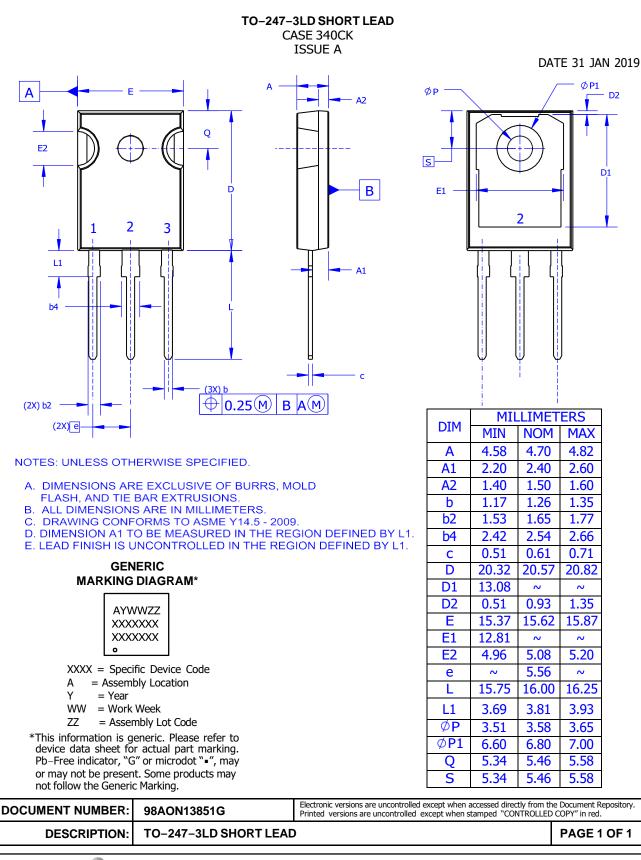


Figure 19. Transient Thermal Impedance of IGBT





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